MAPS/DECAL Status

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Motivation

- Average number of charged particles in an EM shower \propto incident energy
 - Fluctuations around the average occur due to statistical nature of the shower
- Average energy deposited in the sensitive layers \propto number of charged particles
 - Fluctuations around the average occur due to angle of incidence, velocity and Landau spread



- Number of charged particles is an intrinsically better measure than the energy deposited
 - Energy deposited ("analogue" ECAL) resolution ~50% worse than number of particles ("digital" ECAL) resolution
- Can we measure the number of charged particles directly?
 - Can we get anywhere near the ideal resolution?

Digital ECAL concept

- Make pixellated detector with small pixels
 - Probability of more than one charged particle per pixel must be small
 - Allows binary readout = hit/no hit
- EM shower density $\sim 100/mm^2$ in core so need pixels $\sim 50 \mu m$
 - Results in huge number of pixels in a real ECAL $\sim 10^{12}$ pixels



- Cannot afford to have external electronics with individual connections to so many channels
 - Need readout integrated into pixel
 - Implement as CMOS MAPS sensor
 - Includes deep p-well process to shield PMOS circuit transistors
- Very high granularity should help with PFA too
 - Requires major systematic study; here concentrate on EM resolution

TPAC1.0 sensor

- 168×168 pixels = 28k total, each $50 \times 50 \mu m^2$
 - 0.18µm CMOS process
- Two major pixel variants, each in two capacitor combinations
 - Only one major variant worked well; "preShaper"
 - Both minor variants (Quad0 and Quad1) worked
 - All results shown are from this type



4

- Every pixel has 4 diodes, Q-preamp, mask and 4-bit pedestal trim, asynchronous comparator and monostable to give hit/no hit response
- Pixel hits stored with 13-bit timestamp on-sensor until end of bunch train
- Memory for data storage inactive; 11% dead area in four columns



Calibration using ⁵⁵Fe

- ⁵⁵Fe gives 5.9keV photon
 - Deposits all energy in $\sim 1\mu m^3$ volume in silicon; 1640e⁻
 - If within diode, then all charge registered in single pixel with no diffusion
- Binary readout mean measurement need threshold scan
 - Need to differentiate distribution to get signal peak in threshold units (TU)



• Signal peak ~200TU above pedestal; $1TU \sim 8e^{-} \sim 30eV$ deposited

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Single pixel noise performance

- Also need threshold scan to see pedestal and noise
 - Comparator fires on signal going high across threshold level
 - No hits when far above or below threshold
 - Width of distribution equivalent to noise





• RMS ~ $5.5TU \sim 44e^{-} \sim 170eV$ on average

- Minimum is $\sim 4TU \sim 32e^{-} \sim 120eV$
- Target level was ~ 90eV
- No correlation with position on sensor
- Spread not fully understood
- Quad1 ~ 20% larger than Quad0



- Quad1 ~40% more gain than Quad0
- Quad1 ~20% better S/N than Quad0

- Silicon transparent to 1064nm light so illuminate from back side of sensor
- Again need to do threshold scan and find edge



Charge spread

- Charge diffuses to neighbouring pixels
 - Reduces signal in "hit" pixel
 - Causes hits in neighbouring pixels
 - Need to make sure this is correctly modelled
- Simulation using Sentaurus package
 - Full 3D finite element model
 - 3×3 pixel array = $150 \times 150 \mu m^2$ area
 - Thickness of silicon to 32µm depth; covers epitaxial layer of 12µm plus some of substrate
- Use laser to fire at 21 points within pixel
 - Laser spot size < $2\mu m$, step size $1\mu m$
 - Points numbered 0-20, 5µm apart
 - Symmetry means these cover whole pixel surface
- Measure signal using threshold scan in centre pixel and all eight neighbours
 - Numbered "Cell 1" to "Cell 9"



Charge spread results

- Simulation reasonably reproduces the spatial dependence
 - Small differences near diodes (points 9,13,14)
- Average signal over whole pixel $\sim 35\%$ of deposited signal
 - Total charge is $1300e^{-}$ so average $\sim 450e^{-}$
 - Average signal/noise ~ 10
- Worst case signal in central pixel is when hitting corner

- Gives $\sim 24\%$ of total charge so $\sim 300e^-$ and $S/N\sim 7$





Simulation expectation

- Shown at LCWS07 but with no verification of assumptions
 - Now have concrete noise values and measured charge diffusion
- Current extrapolation to "real" detector shows significant degradation of ideal DECAL resolution
 - 35% increase in error
 - Number if pixels hit not trivially related to number of charged tracks
- Degradation arises from
 - Noise hits
 - Dead area
 - Particles sharing pixels
 - Particles crossing pixels boundaries
 - Charge diffusion to neighbouring pixels
- Importance of various effects differs



Effect of noise

- Noise adds hits to showers so increases √N
 - Depends very strongly on threshold
- Need to increase threshold above noise "wall"
 - Noise has no effect for higher thresholds
 - Gain spread ~12% is equivalent to threshold spread here so small effect
- Resolution degradation $\sim 10\%$
 - If S/N can be improved, then get a plateau so noise has no effect on resolution



Effect of dead area

- Sensor has 11% dead region due to on-pixel memory
 - Bands of 250µm wide spaced every 2.4mm
- Shower width ~ 1cm so every shower sees several dead bands
 - Always loses 11% of hits with small fluctuations
- Since $\sigma_E / E \propto 1 / \sqrt{N}$, impact is not large
 - Gives $1/\sqrt{(0.89)} \sim 1.06$ effect
 - Hence $\sim 5\%$ degradation
- Assumes sensor large enough that edge effects are negligible
 - May add ~ 5% more dead area in reality so ~ 2% more to resolution



Effect of hit confusion per particle



- Need to do neighbouring hit "clustering" to convert hits to particle count
 - Algorithm to use depends on effects which may not be modelled well
- Major study of clustering algorithms still to be done
 - Currently gives $\sim 20\%$ degradation to resolution so dominates
 - Essential to get experimental data on fine structure of showers to know realistic resolution

- Arises from
 - Particles close together
 - Particles crossing pixel boundaries
 - Charge diffusion
- Only the last is known to be well modelled



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Short term future plans

- "Debugged" version, TPAC1.1 due back on Sept 23
 - All pixels uniform; Quad1 preShaper variant
 - Decoupled power mesh, thought to cause pickup between pixels (and disrupted beam data)
 - Adjusted pixel circuit layout to improve gain and S/N
 - Trim setting has six not four bits to allow finer trim adjustment
 - Other small fixes, e.g. fix low level of memory corruption <1%
- Pin-compatible with existing PCB
 - Can reuse all readout hardware and firmware
 - Very minor changes to software; only for six trim bits
- Will checked sensor performance fully over next year
 - Including beam test at DESY early in 2009
 - Dec 2007 beam test data unusable as bad pedestal trimming (due to pickup)
- Beam test will have at most four layers, each with a single sensor
 - Data in usual CALICE raw data format although LCIO conversion would need work
 - Will see real data samples of showers at various depths in tungsten
 - Compare with simulation at 50µm granularity
 - Check critical issues of charged particle separation and keV photon flux
 - But will probably not verify true performance as a DECAL...

Long term future plans

- Submitting a proposal this week for large sensor TPAC2
 - 450×450 pixels and 2.5×2.5cm²; a factor ten in area; otherwise a scaled-up TPAC1
 - Bid includes funding for 16-layer Si-W DECAL stack; 5×5 sensors = 12.5×12.5 cm² per layer
 - Smaller than AECAL but OK for basic proof-of-principle
- To pack sensors in the plane, will wirebond through slots in PCB
 - Aim for pixel-pixel gap between sensors to be only $500 \mu m \sim 4\%$ extra dead area
 - "Real" detector would bump-bond but we need to minimise engineering effort for this programme
- A rough schedule
 - Sensor design in 2009
 - Stack assembly and system tests in 2010
 - Beam test of stack in 2011
- BUT... not cheap, UK funding still very difficult
 - External collaborators very much welcome
 - Would very significantly increase probability of approval if cost split with non-UK groups





Conclusions

- **DECAL** seems possible in principle
- Actual EM resolution which would be obtained depends heavily on details of showers and on algorithm for clustering
- The simulation has not been verified at small granularities
- Essential to get real data to compare
- Will have first look at showers early in 2009
- May have first look at EM resolution in 2011
- Approval very uncertain; collaborators very welcome!

Backup: Single pixel pedestals

- Pedestal given by mean of threshold scan
 - Pedestal spread is ~ 4 times noise





- Must correct using trims to get sensible data
 - Trimming works reasonably well; down to RMS of ~ 4.5TU
 - Still not completely below noise level so more trim bits would help

Backup: Pedestal and noise over sensor



Backup: pixel hit pickup

• Find different results for pixel if other pixels enabled



• Prevented pedestals from being determined until effect understood

- Plots shown previously had most pixel masked
- Not found before Dec 2007 beam test so data had bad trims; probably unusable
- Probably due to shared power mesh for comparators and monostables
 - If $>\sim 100$ pixels fire comparators at same time, power droops and fires other monostables
 - Not an major issue for normal use (once understood)

Backup: DECAL 16-layer stack

- Should give definitive answer to whether DECAL concept is viable
- 16 layers gives degraded resolution by factor ~ 2
- Funding not available for more layers
- Hopefully extrapolate to realistic calorimeter sampling using simulation

